



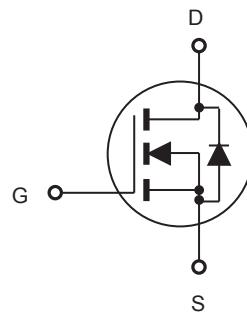
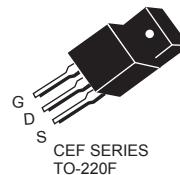
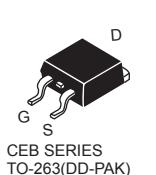
# CEPF634/CEBF634 CEIF634/CEFF634

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

Type	V <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>	@V <sub>GS</sub>
CEPF634	250V	0.45Ω	8.1A	10V
CEBF634	250V	0.45Ω	8.1A	10V
CEIF634	250V	0.45Ω	8.1A	10V
CEFF634	250V	0.45Ω	8.1A <sup>d</sup>	10V

- Super high dense cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handing capability.
- Lead free product is acquired.
- TO-220 & TO-263 & TO-262 package & TO-220F full-pak for through hole.



### ABSOLUTE MAXIMUM RATINGS T<sub>C</sub> = 25°C unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263/262	TO-220F	
Drain-Source Voltage	V <sub>DS</sub>	250		V
Gate-Source Voltage	V <sub>GS</sub>	±20		V
Drain Current-Continuous @ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 100°C	I <sub>D</sub>	8.1 5.1	8.1 <sup>d</sup> 5.1 <sup>d</sup>	A
Drain Current-Pulsed <sup>a</sup>	I <sub>DM</sub> <sup>e</sup>	32	32 <sup>d</sup>	A
Maximum Power Dissipation @ T <sub>C</sub> = 25°C - Derate above 25°C	P <sub>D</sub>	74 0.59	38 0.3	W W/°C
Operating and Store Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C

### Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	1.7	3.3	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	65	°C/W



# CEPF634/CEBF634 CEIF634/CEFF634

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	250			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 250\text{V}, V_{\text{GS}} = 0\text{V}$		25		$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 4.5\text{A}$		0.45		$\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 50\text{V}, I_{\text{D}} = 5.1\text{A}$		4.4		S
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		925		pF
Output Capacitance	$C_{\text{oss}}$			95		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			20		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 125\text{V}, I_{\text{D}} = 5.6\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 12\Omega$		16	32	ns
Turn-On Rise Time	$t_r$			3.5	7	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			38	76	ns
Turn-Off Fall Time	$t_f$			4	8	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 200\text{V}, I_{\text{D}} = 5.6\text{A}, V_{\text{GS}} = 10\text{V}$		18	23	nC
Gate-Source Charge	$Q_{\text{gs}}$			3		nC
Gate-Drain Charge	$Q_{\text{gd}}$			5		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$ <sup>f</sup>				8.1	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 8.1\text{A}$		0.9	1.5	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature .
- b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$  .
- c.Guaranteed by design, not subject to production testing.
- d.Limited only by maximum temperature allowed .
- e .Pulse width limited by safe operating area .
- f .Full package  $I_{\text{S}(\text{max})} = 6\text{A}$  .
- g .UIS condition  $V_{\text{dd}}=25\text{V} L=2\text{mH} R_{\text{g}}=25\text{ohm} I_{\text{as}}=8.1\text{A}$  .

**CEPF634/CEBF634**  
**CEIF634/CEFF634**

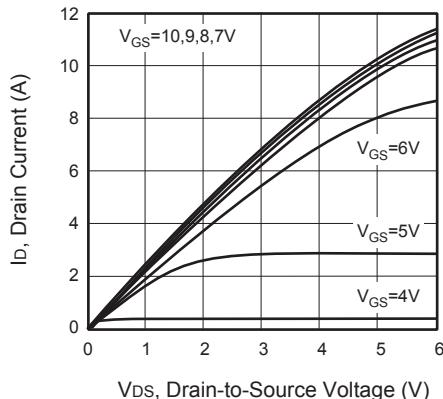


Figure 1. Output Characteristics

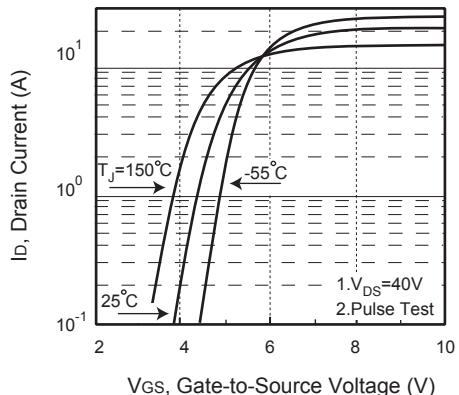


Figure 2. Transfer Characteristics

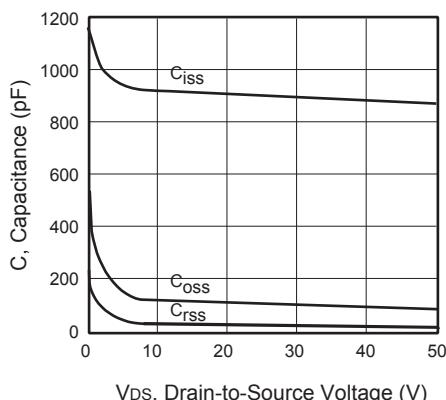


Figure 3. Capacitance

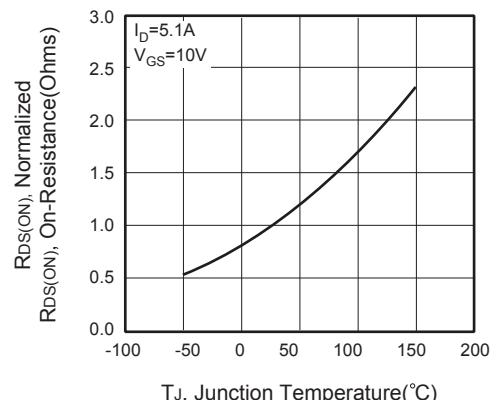


Figure 4. On-Resistance Variation with Temperature

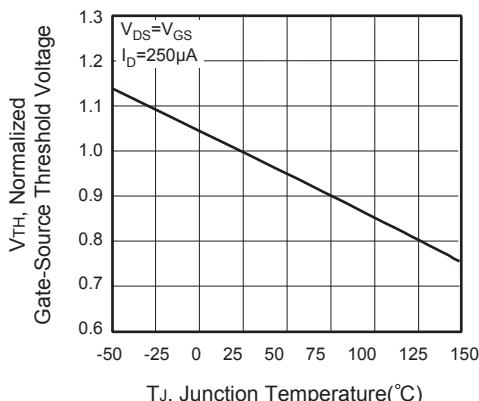


Figure 5. Gate Threshold Variation with Temperature

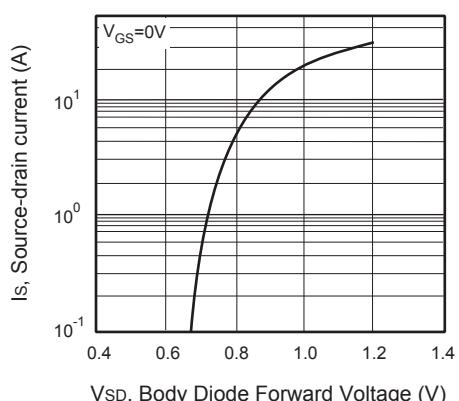


Figure 6. Body Diode Forward Voltage Variation with Source Current

**CEPF634/CEBF634**  
**CEIF634/CEFF634**

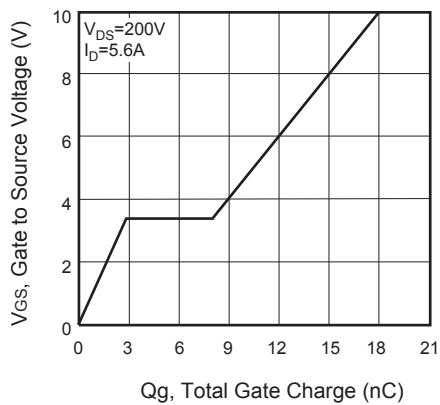


Figure 7. Gate Charge

# CEPF634/CEBF634 CEIF634/CEFF634

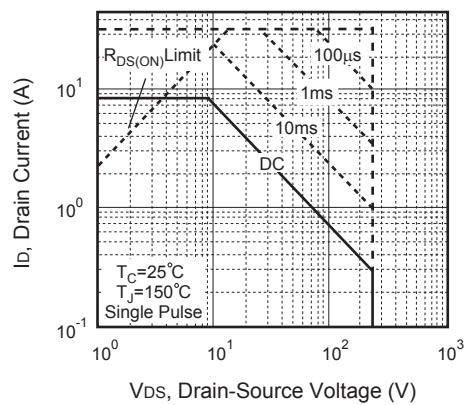


Figure 8. Maximum Safe Operating Area

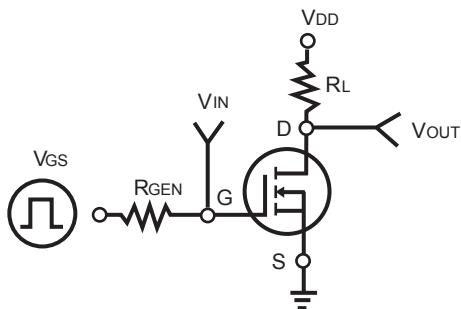


Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

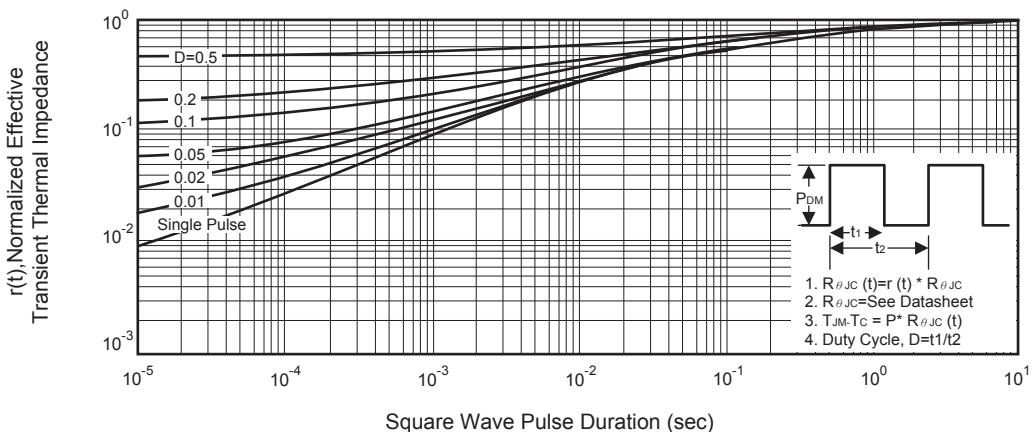


Figure 11. Normalized Thermal Transient Impedance Curve